RGTVX6TS65D

650V 80A Field Stop Trench IGBT

Datasheet

V _{CES}	650V
I _{C (100°C)}	80A
V _{CE(sat) (Typ.)}	1.5V
P_D	404W

Outline TO-247N

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching & Low Switching Loss
- 3) Short Circuit Withstand Time 2µs
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating; RoHS Compliant

Application

Solar Inverter

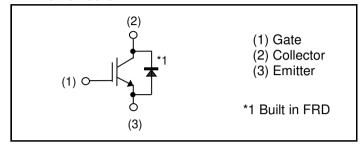
UPS

Welding

ΙH

PFC

●Inner Circuit



Packaging Specifications

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	Packaging	Tube			
	Reel Size (mm)	-			
Tyma	Tape Width (mm)	-			
Туре	Basic Ordering Unit (pcs)	450			
	Packing Code	C11			
	Marking	RGTVX6TS65D			

● **Absolute Maximum Ratings** (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		$V_{\sf CES}$	650	V
Gate - Emitter Voltage	Gate - Emitter Voltage		±30	V
Callegton Comment	T _C = 25°C	I _C	144	Α
Collector Current	T _C = 100°C	I _C	80	Α
Pulsed Collector Current	Pulsed Collector Current		320	Α
Diode Forward Current	T _C = 25°C	I _F	127	Α
	T _C = 100°C	I _F	80	Α
Diode Pulsed Forward Current	Diode Pulsed Forward Current		320	Α
Power Dissipation	T _C = 25°C	P _D	404	W
	T _C = 100°C	P _D	202	W
Operating Junction Temperature		T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by T_{jmax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
Farameter		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.37	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	1	0.57	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
i arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	650	ı	ı	V
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	1	1	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 57.1 \text{mA}$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_{C} = 80A, V_{GE} = 15V,$ $T_{j} = 25^{\circ}C$ $T_{j} = 175^{\circ}C$	-	1.5 1.85	1.9 -	٧

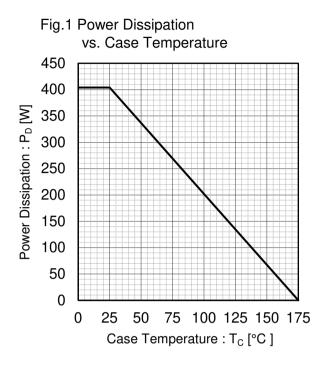
●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

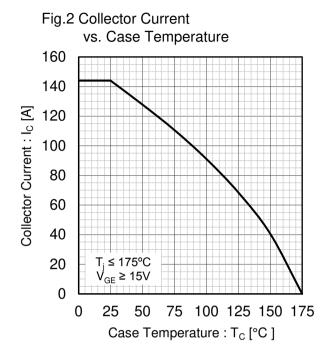
Parameter	Symbol	Conditions		Unit		
			Min.	Тур.	Max.	Offic
Input Capacitance	C _{ies}	$V_{CE} = 30V$,	-	4810	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$,	-	184	-	рF
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	79	-	
Total Gate Charge	Q_g	V _{CE} = 400V,	-	171	-	
Gate - Emitter Charge	Q_{ge}	$I_{\rm C} = 80A$,	-	33	-	nC
Gate - Collector Charge	Q_{gc}	$V_{GE} = 15V$	-	59	-	
Turn - on Delay Time	t _{d(on)}		-	45	-	
Rise Time	t _r	$I_{C} = 80A, V_{CC} = 400V,$ $V_{GE} = 15V, R_{G} = 10\Omega,$	-	29	-	20
Turn - off Delay Time	t _{d(off)}	$T_i = 25^{\circ}C$	-	201	-	ns mJ
Fall Time	t _f	Inductive Load	-	34	-	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	2.65	-	
Turn - off Switching Loss	E _{off}	Tovoise recovery	-	1.80	-	
Turn - on Delay Time	t _{d(on)}	$I_{C} = 80A, V_{CC} = 400V,$ $V_{GE} = 15V, R_{G} = 10\Omega,$ $T_{i} = 175^{\circ}C$	-	49	-	ns
Rise Time	t _r		-	34	-	
Turn - off Delay Time	$t_{d(off)}$		-	218	-	
Fall Time	t _f	Inductive Load	-	80	-	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	2.74	-	m l
Turn - off Switching Loss	E _{off}	10001001001	-	2.31	-	mJ
Reverse Bias Safe Operating Area	RBSOA	$I_C = 320A$, $V_{CC} = 520V$, $V_P = 650V$, $V_{GE} = 15V$, $R_G = 100\Omega$, $T_j = 175^{\circ}C$	FULL SQUARE		-	
Short Circuit Withstand Time	t _{sc}	$V_{CC} \le 360V$, $V_{GE} = 15V$, $T_j = 25^{\circ}C$	2	-	-	μs

•FRD Electrical Characteristics (at $T_j = 25$ °C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
		$I_F = 80A$,				
Diode Forward Voltage	V_{F}	$T_j = 25^{\circ}C$	-	1.45	1.9	V
		T _j = 175°C	-	1.55	-	
Diode Reverse Recovery Time	t _{rr}	$I_F = 80A,$ $V_{CC} = 400V,$ $di_F/dt = 200A/\mu s,$ $T_j = 25^{\circ}C$	-	109	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	12.8	1	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.79	1	μC
Diode Reverse Recovery Energy	E _{rr}		-	30.0	ı	μJ
Diode Reverse Recovery Time	t _{rr}	$I_F = 80A,$ $V_{CC} = 400V,$ $di_F/dt = 200A/\mu s,$ $T_j = 175^{\circ}C$	-	204	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	18.2	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	2.22	-	μC
Diode Reverse Recovery Energy	E _{rr}		-	119.3	-	μJ

Electrical Characteristic Curves





1000

| Variable | Va

Fig.3 Forward Bias Safe Operating Area

400 350 Collector Current : I_C [A] 300 250 200 150 100 50 T_i ≤ 175°C $V_{GF} = 15V$ 0 200 400 600 800 Collector To Emitter Voltage: V_{CE} [V]

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Fig.4 Reverse Bias Safe Operating Area

● Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

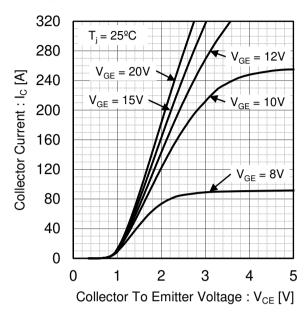


Fig.6 Typical Output Characteristics

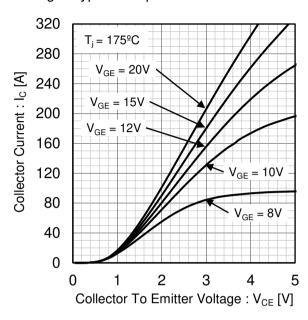


Fig.7 Typical Transfer Characteristics

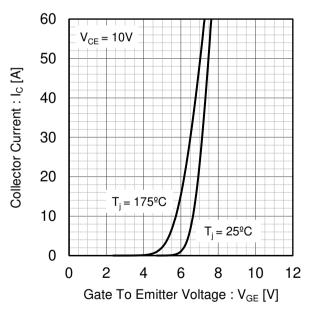
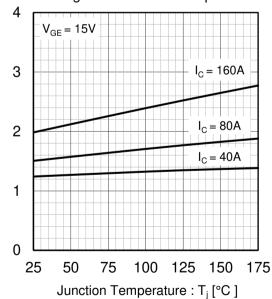


Fig.8 Typical Collector to Emitter Saturation Voltage vs. Junction Temperature



Collector To Emitter Saturation

Voltage: V_{CE(sat)} [V]

Electrical Characteristic Curves

Fig.9 Typical Collector to Emitter Saturation Voltage vs. Gate to Emitter Voltage

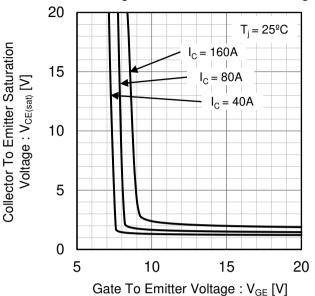


Fig.10 Typical Collector to Emitter Saturation Voltage vs. Gate to Emitter Voltage

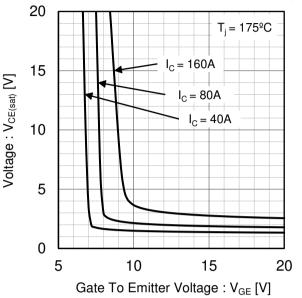


Fig.11 Typical Switching Time vs. Collector Current

1000 $t_{d(off)}$ 100 $t_{d(off)}$ $t_{d(onf)}$ $t_{d(onf)}$ 100 t_{r} $t_$

vs. Gate Resistance 1000 $t_{d(off)}$ Switching Time [ns] 100 t_r 10 V_{CC} = 400V, V_{GE} = 15V, I_C = 80A, T_j = 175 $^{\circ}$ C Inductive load 1 0 10 20 30 40 50 Gate Resistance : R_{α} [Ω]

Fig.12 Typical Switching Time

Collector To Emitter Saturation



0.01

20

40

Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current

10 E_{off} E_{on} $V_{CC} = 400V, V_{GE} = 15V, R_{G} = 10\Omega, T_{J} = 175^{\circ}C$ Inductive load

60 80 100 120 140 160

Collecter Current : I_C [A]

vs. Gate Resistance

10 E_{on} E_{off} 10 $V_{CC} = 400V, I_{C} = 80A, V_{GE} = 15V, T_{J} = 175^{\circ}C$ Inductive load

0 10 20 30 40 50

Gate Resistance : R_{G} [Ω]

Fig.14 Typocal Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector to Emitter Voltage 10000 \mathbf{C}_{ies} 1000 Capacitance [pF] C_{oes} 100 $\mathsf{C}_{\mathsf{res}}$ 10 f = 1MHz $V_{GE} = 0V$ $T_i = 25^{\circ}C$ 1 0.01 0.1 10 100 Collector To Emitter Voltage: V_{CE} [V]

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Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage

320
280

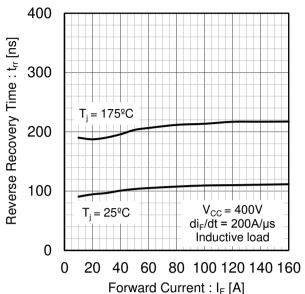
Very 240

Typical Diode Forward Current vs. Forward Voltage

320
Typical Diode Forward Current vs. Forward Voltage

320
Typical Diode Forward Current vs. Forward Current vs. Forward Voltage

Fig.18 Typical Diode Revese Recovery Time vs. Forward Current



160
120
80
40
0
0
0
0.5 1 1.5 2 2.5
Forward Voltage : $V_F[V]$

3

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

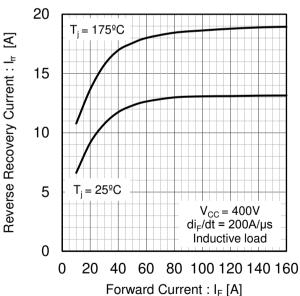
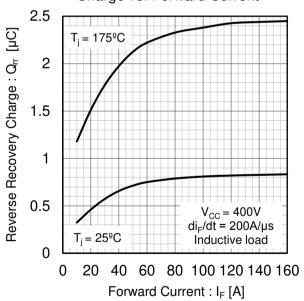


Fig.20 Typical Diode Rrverse Recovery Charge vs. Forward Current



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● Electrical Characteristic Curves

Fig.21 Typical IGBT Transient Thermal Impedance

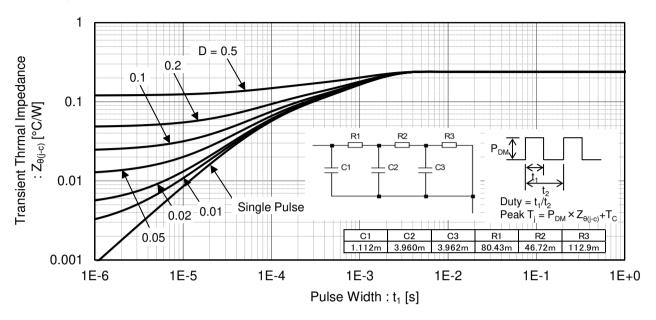
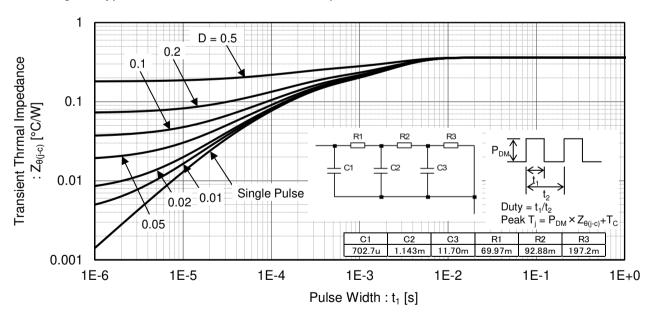


Fig.22 Typical Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

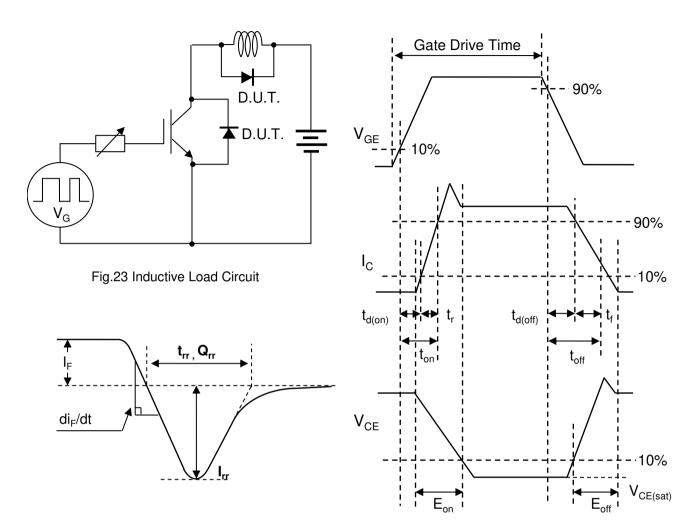


Fig.25 Diode Reverse Recovery Waveform

Fig.24 Inductive Load Waveform

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